

BCR8PM-12LE

Triac

Medium Power Use

REJ03G1259-0100 Rev.2.00 Jul 28, 2006

Features

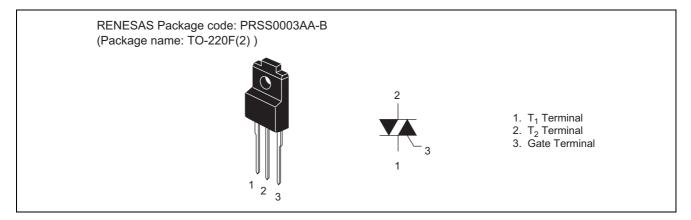
I_{T (RMS)}: 8 A
 V_{DRM}: 600 V

• I_{FGTI}, I_{RGTI}, I_{RGTIII}: 30 mA

• Viso: 1500 V

- Insulated Type
- Planar Passivation Type
- UL Applying

Outline

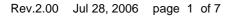


Applications

Switching mode power supply, light dimmer, electronic flasher unit, control of household equipment such as TV sets, stereo systems, refrigerator, washing machine, infrared kotatsu, and carpet, solenoid driver, small motor control, copying machine, electric tool, electric heater control, and other general purpose control applications

Maximum Ratings

Parameter	Symbol	Voltage class	Unit
Repetitive peak off-state voltage ^{Note1}	V_{DRM}	600	V
Non-repetitive peak off-state voltage ^{Note1}	V_{DSM}	700	V





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Parameter	Symbol	Ratings	Unit	Conditions
RMS on-state current	I _{T (RMS)}	8	Α	Commercial frequency, sine full wave 360° conduction, Tc = 82°C
Surge on-state current	I _{TSM}	80	А	60Hz sinewave 1 full cycle, peak value, non-repetitive
I ² t for fusing	l ² t	26	A ² s	Value corresponding to 1 cycle of half wave 60Hz, surge on-state current
Peak gate power dissipation	P _{GM}	5	W	
Average gate power dissipation	P _{G (AV)}	0.5	W	
Peak gate voltage	V_{GM}	10	V	
Peak gate current	I _{GM}	2	Α	
Junction temperature	Tj	- 40 to +125	°C	
Storage temperature	Tstg	- 40 to +125	°C	
Mass	_	2.0	g	Typical value
Isolation voltage	Viso	1500	V	Ta = 25°C, AC 1 minute, $T_1 \cdot T_2 \cdot G$ terminal to case

Notes: 1. Gate open.

Electrical Characteristics

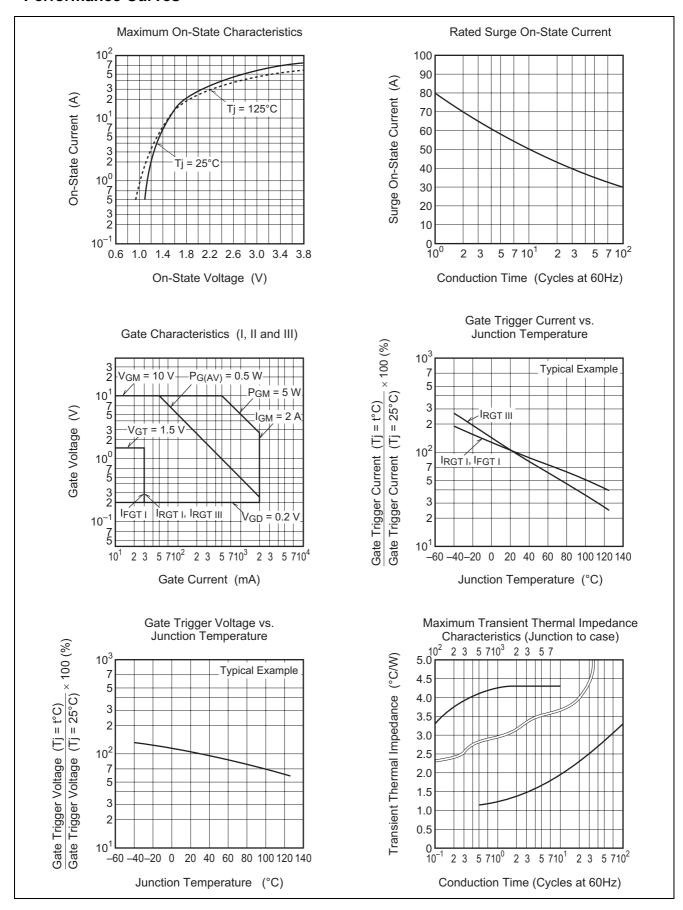
Parameter		Symbol	Min.	Тур.	Max.	Unit	Test conditions	
Repetitive peak off-state current		I _{DRM}	_	_	2.0	mA	Tj = 125°C, V _{DRM} applied	
On-state voltage		V_{TM}	_	_	1.6	V	Tc = 25°C, I _{TM} = 12 A, Instantaneous measurement	
Gate trigger voltage ^{Note2}	I	V_{FGTI}		_	1.5	V	$Tj = 25$ °C, $V_D = 6$ V, $R_L = 6$ Ω,	
	II	V_{RGTI}		_	1.5	V	$R_G = 330 \Omega$	
	III	V_{RGTIII}		_	1.5	V		
Gate trigger current ^{Note2}	I	I _{FGTI}	-	_	30	mA	$T_j = 25$ °C, $V_D = 6$ V, $R_L = 6$ Ω,	
		I_{RGTI}		_	30	mA	$R_G = 330 \Omega$	
	III	I_{RGTIII}	_	_	30	mA		
Gate non-trigger voltage		V_{GD}	0.2	_	_	V	$Tj = 125$ °C, $V_D = 1/2 V_{DRM}$	
Thermal resistance		R _{th (j-c)}	_	_	4.3	°C/W	Junction to case ^{Note3}	
Critical-rate of rise of off-state commutating voltage ^{Note4}		(dv/dt)c	10	_	_	V/µs	Tj = 125°C	

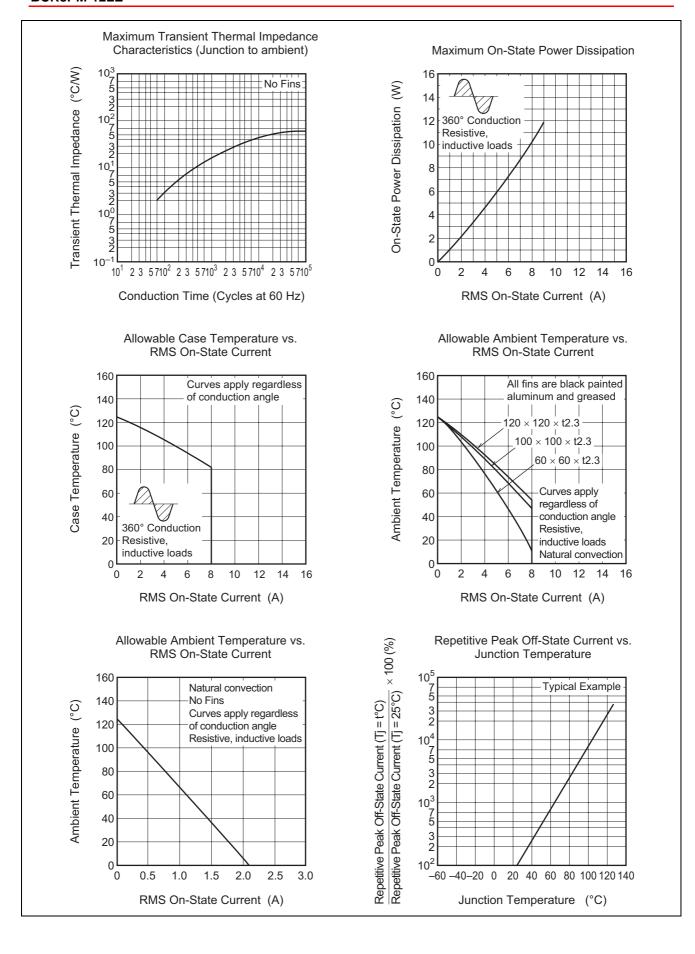
Notes: 2. Measurement using the gate trigger characteristics measurement circuit.

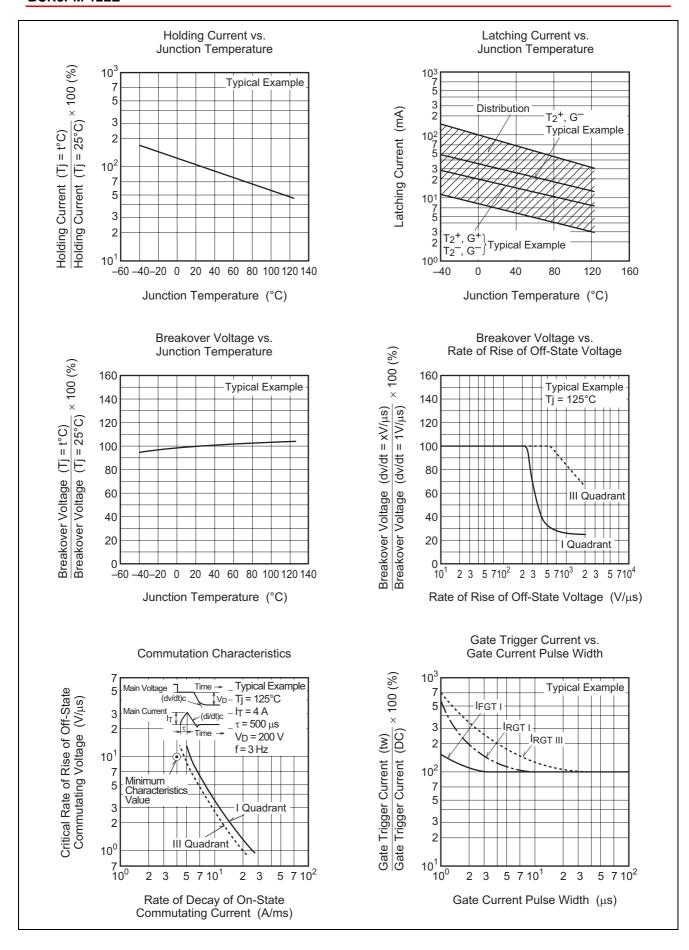
- 3. The contact thermal resistance $R_{th\ (c\text{-}f)}$ in case of greasing is 0.5°C/W.
- 4. Test conditions of the critical-rate of rise of off-state commutating voltage is shown in the table below.

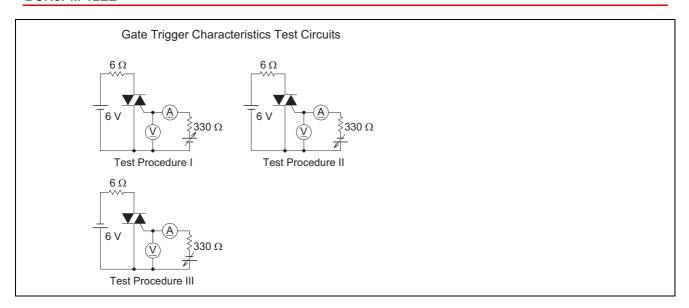
Test conditions	Commutating voltage and current waveforms (inductive load)
1. Junction temperature Tj = 125°C	Supply Voltage → Time
2. Rate of decay of on-state commutating current (di/dt)c = - 4.0 A/ms	Main Current (di/dt)c
3. Peak off-state voltage V _D = 400 V	Main Voltage Time (dv/dt)c

Performance Curves

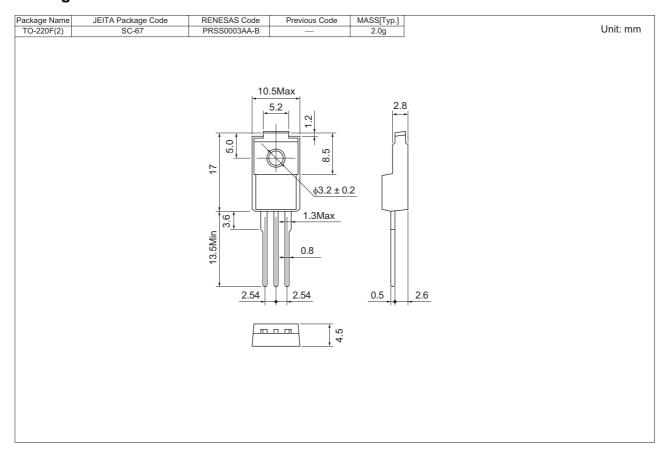








Package Dimensions



Order Code

Lead form	Standard packing	Quantity	Standard order code	Standard order code example
Straight type	Vinyl sack	100	Type name	BCR8PM-12LE
Lead form	Plastic Magazine (Tube)	50	Type name – Lead forming code	BCR8PM-12LE-A8

Note: Please confirm the specification about the shipping in detail.

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